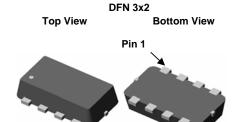


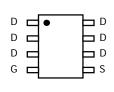


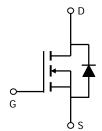
AON4420L

N-Channel Enhancement Mode Field Effect Transistor

General Description	Features		
The AON4420L combines advanced trench MOSFET technology with a small footprint package to provide low $R_{\text{DS(ON)}}$ per unit area. This device is ideal for load switch and high speed switching applications.	V_{DS} (V) = 30V I_{D} = 10A $R_{DS(ON)}$ < 19mΩ $R_{DS(ON)}$ < 25mΩ	$(V_{GS} = 10V)$ $(V_{GS} = 10V)$ $(V_{GS} = 4.5V)$	
- RoHS Compliant - Halogen Free			







Absolute Maximum Ratings T _A =25°C unless otherwise noted						
Parameter		Symbol	Maximum	Units		
Drain-Source Voltage		V_{DS}	30	V		
Gate-Source Voltage		V_{GS}	±20	V		
Pulsed Drain Current	C	I _{DM}	50			
Continuous Drain	T _A =25°C		10	Λ		
Current ^A	T _A =70°C	I _D	8	A		
	T _A =25°C	В	1.6	W		
Power Dissipation A	T _A =70°C	$-P_{D}$	1	¬		
Junction and Storage	Temperature Range	T _J , T _{STG}	-55 to 150	°C		

Thermal Characteristics					
Parameter	Symbol	Тур	Max	Units	
Maximum Junction-to-Ambient A	t ≤ 10s	$R_{ hetaJA}$	34	40	°C/W
Maximum Junction-to-Ambient A	Steady-State	IN _θ JA	66	80	°C/W
Maximum Junction-to-Lead ^B	Steady-State	$R_{ hetaJL}$	20	25	°C/W

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units	
STATIC PARAMETERS							
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0V$	30			V	
I _{DSS}	Zero Gate Voltage Drain Current $V_{DS} = 30V, V_{GS} = 0V$	20 1 00			1	μА	
	·	T _J = 55°C			5		
I _{GSS}	Gate-Body leakage current	$V_{DS} = 0V$, $V_{GS} = \pm 20V$			±100	nA	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS} I_D = 250 \mu A$	1.4	1.9	2.5	V	
$I_{D(ON)}$	On state drain current	$V_{GS} = 10V, V_{DS} = 5V$	50			Α	
	R _{DS(ON)} Static Drain-Source On-Resistance	$V_{GS} = 10V, I_D = 10A$		16	20		
$R_{DS(ON)}$		T _J =125°C		27		mΩ	
		$V_{GS} = 4.5V, I_D = 8A$		21	26		
g FS	Forward Transconductance	$V_{DS} = 5V, I_{D} = 10A$		30		S	
V_{SD}	Diode Forward Voltage	$I_S = 1A, V_{GS} = 0V$		0.75	1	V	
I _S	Maximum Body-Diode Continuous Current				3	Α	
DYNAMIC	PARAMETERS						
C _{iss}	Input Capacitance		440	550	660	pF	
C _{oss}	Output Capacitance	V_{GS} =0V, V_{DS} =15V, f=1MHz	80	110	140	pF	
C_{rss}	Reverse Transfer Capacitance		35	55	80	pF	
R_g	Gate resistance	V_{GS} =0V, V_{DS} =0V, f=1MHz	2	4	6	Ω	
SWITCHII	NG PARAMETERS						
Q _g (10V)	Total Gate Charge (10V)		8	9.8	12	nC	
Q _g (4.5V)	Total Gate Charge (4.5V)	V _{GS} =10V, V _{DS} =15V, I _D =10A	4	4.6	5.5	nC	
Q_{gs}	Gate Source Charge	V _{GS} -10V, V _{DS} -13V, I _D -10A	1.5	1.8	2.2	nC	
Q_{gd}	Gate Drain Charge] [1.3	2.2	3	nC	
t _{D(on)}	Turn-On DelayTime			5		ns	
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =15V, R_{L} =1.5 Ω ,		3.2		ns	
$t_{D(off)}$	Turn-Off DelayTime	R_{GEN} =3 Ω		24		ns	
t _f	Turn-Off Fall Time]		6		ns	
t _{rr}	Body Diode Reverse Recovery Time	I _F =10A, dI/dt=300A/μs	8	11	14	ns	
Q_{rr}	Body Diode Reverse Recovery Charge	I _F =10A, dI/dt=300A/μs	11	13	16	nC	

A: The value of R $_{\theta,JA}$ is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A = 25°C. The value in any given application depends on the user's specific board design.

Rev0: July 2008

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B: Repetitive rating, pulse width limited by junction temperature.

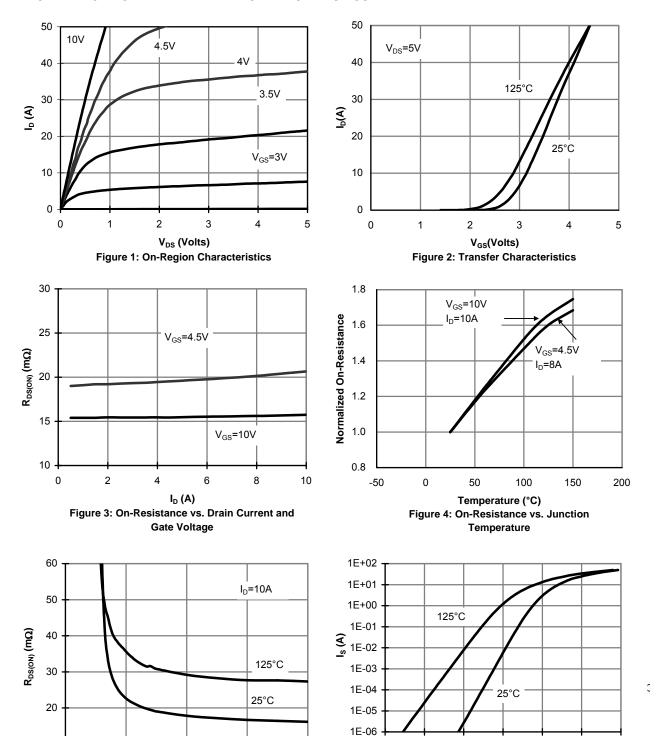
C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using $t \leqslant 300 \mu s$ pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The SOA curve provides a single pulse rating.

F. The current rating is based on the $t \leqslant 10 s$ thermal resistance rating.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



4

6

V_{GS} (Volts)

Figure 5: On-Resistance vs. Gate-Source Voltage

8

10

10

2

1.2

0.6

V_{SD} (Volts)

Figure 6: Body-Diode Characteristics

8.0

1.0

0.0

0.2

0.4

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

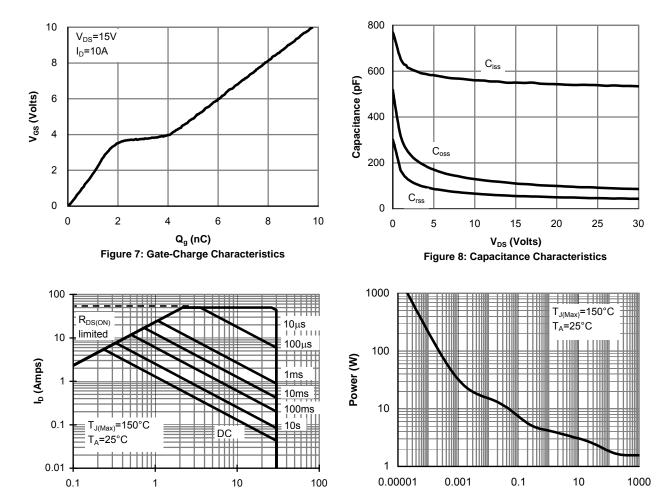


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

V_{DS} (Volts)

Pulse Width (s)
Figure 10: Single Pulse Power Rating Junctionto-Ambient (Note E)

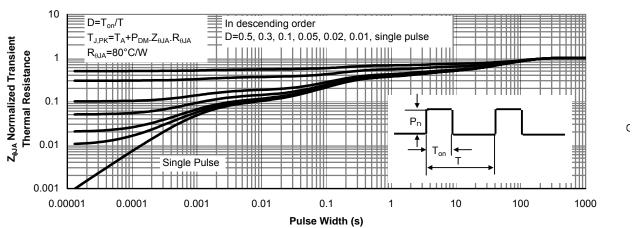
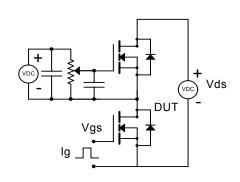
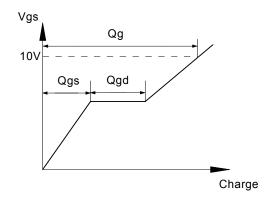


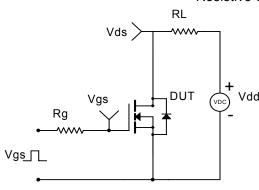
Figure 11: Normalized Maximum Transient Thermal Impedance(Note E)

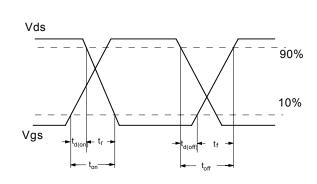
Gate Charge Test Circuit & Waveform





Resistive Switching Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms

